

STFH24N60M2

N-channel 600 V, 0.168 Ω typ., 18 A MDmesh™ M2 Power MOSFET in a TO-220FP wide creepage package

Datasheet - production data

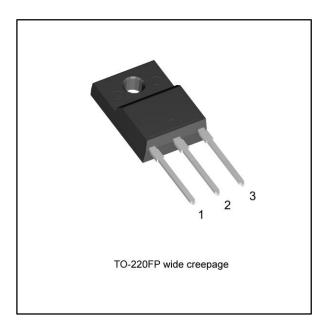
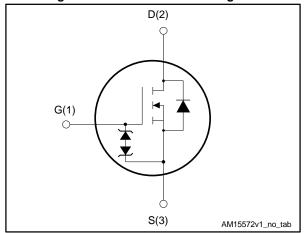


Figure 1: Internal schematic diagram



Features

Order code	V _{DS} @ T _{Jmax}	R _{DS(on)} max	ΙD
STFH24N60M2	650 V	0.19 Ω	18 A

- Extremely low gate charge
- Excellent output capacitance (Coss) profile
- 100% avalanche tested
- Zener-protected
- Wide creepage distance of 4.25 mm between the pins

Applications

- Switching applications
- LLC converters, resonant converters

Description

This device is an N-channel Power MOSFET developed using MDmesh™ M2 technology. Thanks to its strip layout and an improved vertical structure, the device exhibits low on-resistance and optimized switching characteristics, rendering it suitable for the most demanding high efficiency converters.

The TO-220FP wide creepage package provides increased surface insulation for Power MOSFETs to prevent failure due to arcing, which can occur in polluted environments.

Table 1: Device summary

Order code	Marking	Package	Packing
STFH24N60M2	24N60M2	TO-220FP wide creepage	Tube

June 2016 DocID029415 Rev 2 1/12

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STFH24N60M2 Electrical ratings

1 Electrical ratings

Table 2: Absolute maximum ratings

Symbol	Parameter	Value	Unit
V _G s	Gate-source voltage	± 25	V
I _D	Drain current (continuous) at T _C = 25 °C	18 ⁽¹⁾	Α
I _D	Drain current (continuous) at T _C = 100 °C	12 ⁽¹⁾	Α
I _{DM} ⁽²⁾	Drain current (pulsed)	72 ⁽¹⁾	Α
P _{TOT}	Total dissipation at $T_C = 25$ °C	30	W
dv/dt (3)	Peak diode recovery voltage slope	15	V/ns
dv/dt (4)	MOSFET dv/dt ruggedness	50	V/ns
V _{ISO}	Insulation withstand voltage (RMS) from all three leads to external heat sink (t = 1 s; TC = 25 °C)	2500	٧
T _{stg}	Storage temperature range	FF to 150	°C
Tj	Operating junction temperature range	- 55 to 150	

Notes:

Table 3: Thermal data

Symbol	Parameter	Value	Unit
R _{thj-case}	Thermal resistance junction-case max	4.2	°C/W
R _{thj-amb}	Thermal resistance junction-ambient max	62.5	°C/W

Table 4: Avalanche characteristics

Symbol	Parameter	Value	Unit
I _{AR}	Avalanche current, repetitive or not repetitive (pulse width limited by T _{jmax})	3.5	Α
Eas	Single pulse avalanche energy (starting T _j =25 °C, I _D = I _{AR} ; V _{DD} =50 V)	180	mJ

⁽¹⁾Limited by maximum junction temperature.

⁽²⁾Pulse width limited by safe operating area.

 $^{^{(3)}}I_{SD} \leq$ 18 A, di/dt \leq 400 A/µs; VDSpeak < V(BR)DSS, VDD = 400 V.

 $^{^{(4)}}V_{DS} \le 480 \text{ V}.$

Electrical characteristics STFH24N60M2

2 Electrical characteristics

(T_C = 25 °C unless otherwise specified)

Table 5: On /off states

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
V _{(BR)DSS}	Drain-source breakdown voltage	$V_{GS} = 0$, $I_D = 1$ mA	600			V
		V _{GS} = 0, V _{DS} = 600 V			1	μA
I _{DSS}	Zero gate voltage drain current	$V_{GS} = 0,$ $V_{DS} = 600 \text{ V},$ $T_{C}=125 \text{ °C}^{(1)}$			100	μΑ
I _{GSS}	Gate-body leakage current	$V_{DS} = 0$, $V_{GS} = \pm 25 \text{ V}$			±10	μA
V _{GS(th)}	Gate threshold voltage	$V_{DS} = V_{GS}$, $I_D = 250 \mu A$	2	3	4	V
R _{DS(on)}	Static drain-source on- resistance	$V_{GS} = 10 \text{ V}, I_{D} = 9 \text{ A}$		0.168	0.190	Ω

Notes:

Table 6: Dynamic

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
Ciss	Input capacitance		-	1060	-	pF
Coss	Output capacitance	V _{DS} = 100 V, f = 1 MHz,	-	55	-	pF
C _{rss}	Reverse transfer capacitance	$V_{GS} = 0 V$	-	2.2	-	pF
Coss eq. (1)	Equivalent output capacitance	V _{DS} = 0 to 480 V, V _{GS} = 0 V	-	258	-	pF
R _G	Intrinsic gate resistance	f = 1 MHz, I _D =0 A	-	7		Ω
Qg	Total gate charge	V _{DD} = 480 V, I _D = 18 A,	-	29	-	nC
Qgs	Gate-source charge	V _{GS} = 10 V	-	6	1	nC
Q_{gd}	Gate-drain charge	(see Figure 15: "Test circuit for gate charge behavior")	-	12	-	nC

Notes:

⁽¹⁾Defined by design, not subject to production test.

 $^{^{(1)}}$ Coss eq. is defined as a constant equivalent capacitance giving the same charging time as Coss when VDS increases from 0 to 80% VDSS.

Table 7: Switching times

JJJ						
Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
t _{d(on)}	Turn-on delay time	$V_{DD} = 300 \text{ V}, I_{D} = 9 \text{ A},$	ı	14	1	ns
tr	Rise time	$R_G = 4.7 \Omega, V_{GS} = 10 V$	-	9	-	ns
t _{d(off)}	Turn-off delay time	(see Figure 14: "Test circuit for resistive load switching times" and	-	60	-	ns
t _f	Fall time	Figure 19: "Switching time waveform")	-	15	-	ns

Table 8: Source drain diode

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
I _{SD} ⁽¹⁾	Source-drain current		-		18	Α
I _{SDM} ⁽¹⁾⁽²⁾	Source-drain current (pulsed)		-		72	Α
V _{SD} ⁽³⁾	Forward on voltage	I _{SD} = 18 A, V _{GS} = 0 V	-		1.6	V
t _{rr}	Reverse recovery time	I _{SD} = 18 A, di/dt = 100 A/μs	-	332		ns
Qrr	Reverse recovery charge	V _{DD} = 60 V (see Figure 16: "Test circuit for inductive load switching	-	4		μC
I _{RRM}	Reverse recovery current	and diode recovery times")		24		Α
t _{rr}	Reverse recovery time	I _{SD} = 18 A, di/dt = 100 A/μs	-	450		ns
Qrr	Reverse recovery charge	V _{DD} = 60 V, T _j = 150 °C (see Figure 16: "Test circuit for	-	5.5		μC
I _{RRM}	Reverse recovery current	inductive load switching and diode recovery times")	-	25		Α

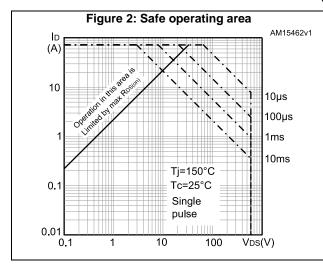
Notes:

 $^{^{(1)}}$ The value is rated according to $R_{\text{thj-case}}$ and limited by package.

⁽²⁾Pulse width limited by safe operating area

 $^{^{(3)}\}text{Pulsed:}$ pulse duration = 300 $\mu\text{s,}$ duty cycle 1.5%

2.1 Electrical characteristics (curves)



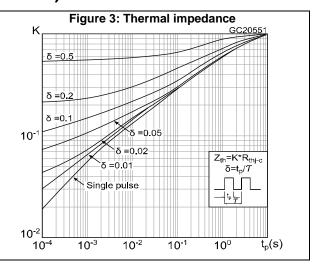
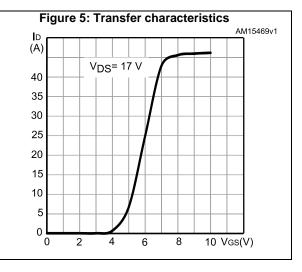
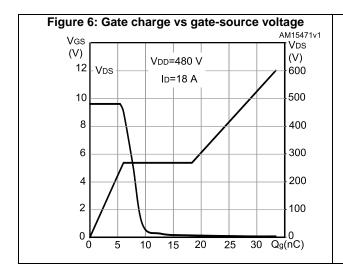
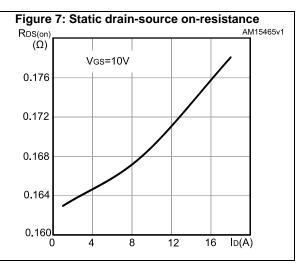


Figure 4: Output characteristics AM15470v1 V_{GS}= 8, 9, 10 V (A) V_{GS}= 7 V 40 35 30 25 V_{GS}= 6 V 20 15 10 V_{GS}= 5 V 5 V_{GS}= 4 V 0 20 VDS(V) 5 10







STFH24N60M2 Electrical characteristics

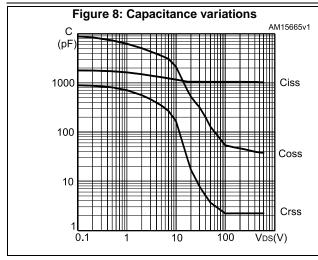


Figure 9: Output capacitance stored energy

AM15472v1

AM15472v1

AM15472v1

AM15472v1

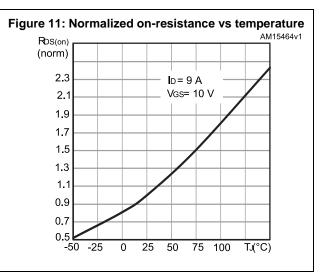
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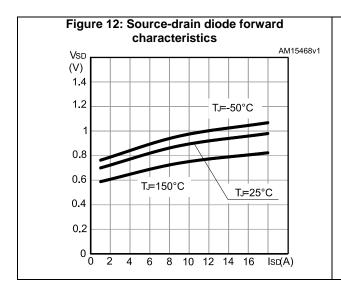
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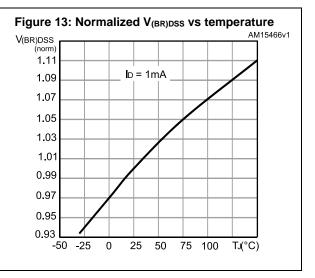
AM15472v1

AM15472v1

Figure 10: Normalized gate threshold voltage vs temperature AM15473v1 VGS(th) (norm) $I_D = 250 \, \mu A$ 1.1 1.0 0.9 0.8 0.7 0.6 -25 0 25 50 75 100 TJ(°C)







Test circuits STFH24N60M2

3 Test circuits

Figure 14: Test circuit for resistive load switching times

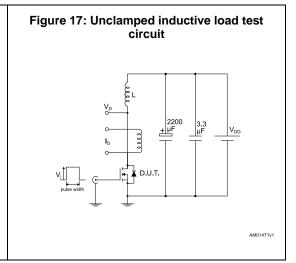
Figure 15: Test circuit for gate charge behavior

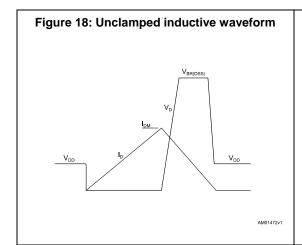
12 V 47 KΩ 100 NF D.U.T.

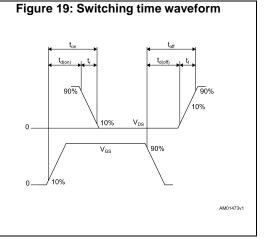
VGS 1 KΩ 100 NF D.U.T.

AM01469v1

Figure 16: Test circuit for inductive load switching and diode recovery times







4 Package information

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK® packages, depending on their level of environmental compliance. ECOPACK® specifications, grade definitions and product status are available at: **www.st.com**. ECOPACK® is an ST trademark.

4.1 TO-220FP wide creepage package information

57 D 14 G1 G Ε

Figure 20: TO-220FP wide creepage package outline

Table 9: TO-220FP wide creepage package mechanical data

Dim		mm	
Dim.	Min.	Тур.	Max.
А	4.60	4.70	4.80
В	2.50	2.60	2.70
D	2.49	2.59	2.69
E	0.46		0.59
F	0.76		0.89
F1	0.96		1.25
F2	1.11		1.40
G	8.40	8.50	8.60
G1	4.15	4.25	4.35
Н	10.90	11.00	11.10
L2	15.25	15.40	15.55
L3	28.70	29.00	29.30
L4	10.00	10.20	10.40
L5	2.55	2.70	2.85
L6	16.00	16.10	16.20
L7	9.05	9.15	9.25
Dia	3.00	3.10	3.20

STFH24N60M2 Revision history

5 Revision history

Table 10: Document revision history

Date	Revision	Changes
07-Jun-2016	1	First release.
16-Jun-2016	2	Document status promoted from preliminary data to production data. Minor text changes.

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